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SPECIFICATION FOR LCM MODULE

MODULE NO.: AMG240160Q-G-W6WFDW DOC.REVISION: 01

Customer Approval:

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DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
00	Nov-6-2009	First issue	Chen
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<u>1. FUNCTIONS & FEATURES</u>

- 1.1. Format
- 1.2. LCD mode
- 1.3. Viewing direction
- 1.4. Driving scheme
- 1.5. Power supply voltage (V_{DD})
- 1.6. LCD driving voltage (VLCD)
- 1.7. Operation temp
- 1.8. Storage temp
- 1.9. Back light
- 1.10. RoHS compliant.

- : 240*160 Dots
- : FSTN /Positive Mode /Transflective
- : 6 o'clock
- : 1/160 Duty cycle, 1/12 Bias
- : 3.3V
 - : 16.0V (Reference voltage)
 - :-20~+70°C
 - :-30~+80°C
 - : EDGE White

2. MECHANICAL SPECIFICATIONS 2.1. Module size : 105.5mm(L)*67.2+58.0mm(F : 105.5mm(L)*67.2+58.0mm(FPC length)mm(W)*4.2mm(H)

- 2.2. Viewing area 2.3. Dot pitch
- : 99.0mm(L)*57.5mm(W) : 0.35mm(L)*0.32mm(W)
 - : 0.33mm(L)*0.30mm(W)
- 2.4. Dot size 2.5. Weight
- : Approx.

3. BLOCK DIAGRAM

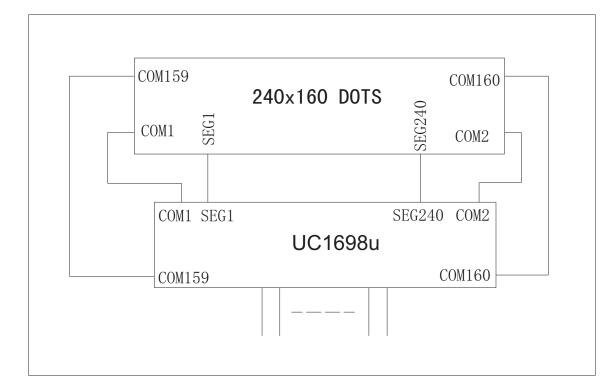


Figure 1.Block diagram

4. DIMENSIONAL OUTLINE

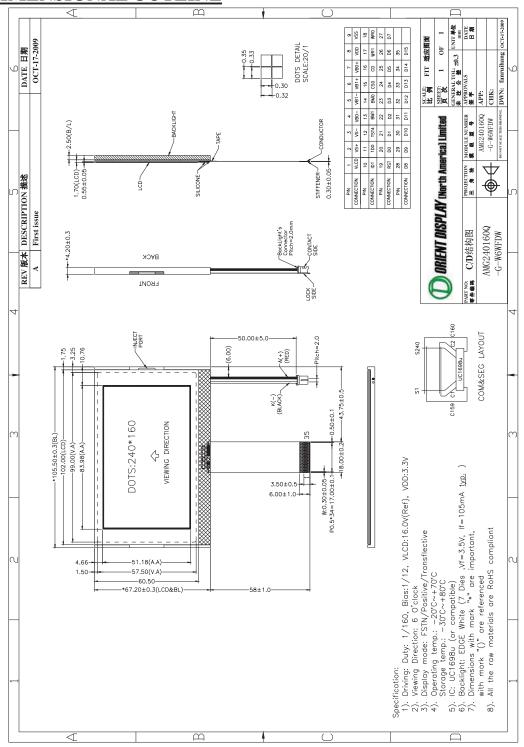


Figure2. Dimensional outline

5. PIN DESCRIPTION

1	VLCD	Power suppl	y for LCD voltage	e								
	VS+, VS-,											
2~7	VB0-, VB1-,	LCD SEG d	riving voltages.									
	VB1+, VB0+											
8	VDD	Power suppl	y for logic(+3.3V)								
9	VSS	Ground	Ground									
	ID1	Selects Inpu	t Data set for 8-bit	mode.								
10			it input data are D it input data are D	[0,2,4,6,8,10,12,14] [0:7]								
10		-	•	available in PID[1:0] with command Get e, connect ID1 to V_{DD} for "H", or V_{SS} for								
11 ID0 pin can be used for production control.												
11		Connect ID0 pin to V _{DD} for "H" or V _{SS} for "L".										
	TST4	hip pull-up resistor. Leave it open										
12		TST4 is also used as one of the high voltage power supply for MTP programming operation. For COG designs, please wire out TST4 with trace resistance between $30 \sim 50 \Omega$.										
			The interface bus 3} by the following	mode is determined by BM[1:0] and g relationship:								
		BM[1:0]	{DB15, DB13}	Mode								
		11	Data	6800/16-bit								
		10	Data	8080/16-bit								
		01	0x	6800/8-bit								
13,14	BM1, BM0	00	0x	8080/8-bit								
		00	10	4-wire SPI w/ 8-bit token (S8: conventional)								
		00	11	3/4-wire SPI w/ 8-bit token (S8uc: Ultra-Compact)								
		01 10 3-wire SPI w/ 9-bit taken (S9: conventional)										
15	CS0	Chip select s	signal									
	CD			y data for read/write operation. In S9 nnect to Vss when not used.								
16 "L": Control data "H": Display data												

		WR[1:0] contro section Host I				host interface	e. See
17,18	WR1,WR0	In parallel mod interface is in modes, these	the 6800 m	ode or the	8080 mode	e. In serial inte	
19	RST	The RESET s	signal				
		Bi-directional	bus for par	allel host in	iterfaces.		
		In serial mode	es, connect	DB[0] to S	CK, DB[8]	to SDA.	
			BM=1x	BM=0x	BM=0x	BM=00	BM=01
			(16-bit)	(8-bit) ID1=0	(8-bit) ID1=1	(S8/S8uc)	(S9)
		DB0 D0 D0/D8 D0/D8 S0	SCK	SCK			
		DB1	D1	-	D1/D9	-	-
		DB2	D2	D1/D9	D2/D10	-	-
		DB3	D3	-	D3/D11	-	-
		DB4	D4	D2/D10	D4/D12	-	-
00.05		DB5	D5	-	D5/D13	-	-
20~35	D0~D15	DB6	D6	D3/D11	D6/D14	-	-
		DB7	D7	-	D7/D15	-	-
		DB8	D8	D4/D12	-	SDA	SDA
		DB9	D9	-	-	-	-
		DB10	D10	D5/D13	-	-	-
		DB11	D11	-	-	-	_
		DB12	D12	D6/D14	-	-	-
		DB13	D13	-	-	0:S8/1:S8uc	0
		DB14	D14	D7/D15	-	-	_
		DB15	D15	0	0	1	1
		Always conne	ct unused	pins to eith	er V _{SS} or V	DD-	

6. MAXIMUM ABSOUTE LIMIT

Maximum Ratings (Voltage Reference to VSS)(for IC)

ABSOLUTE MAXIMUM RATINGS

In accordance with IEC134, Note 1 and 2

Symbol	Parameter	Min.	Max.	Unit
Vdd	Logic Supply voltage	-0.3	+4.0	V
V _{DD2}	LCD Generator Supply voltage	-0.3	+4.0	V
V _{DD3}	Analog Circuit Supply voltage	-0.3	+4.0	V
$V_{DD2/3}$ - V_{DD}	Voltage difference between V_{DD} and $V_{\text{DD2/3}}$		1.6	V
VLCD	LCD Driving voltage (-25°C ~ +75°C)	-0.3	+19.8	V
VIN	Digital input signal	-0.4	V _{DD} + 0.5	V
T _{OPR}	Operating temperature range	-30	+85	°C
T _{STR}	Storage temperature	-55	+125	°C

NOTE:

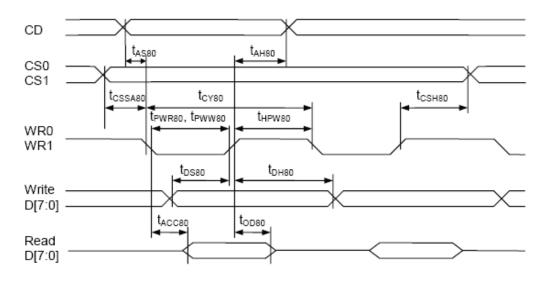
- 1. V_{DD} is based on $V_{SS} = 0V$
- 2. Stress beyond ranges listed above may cause permanent damages to the device.

7. ELECTRICAL CHARACTERISTICS DC CHARACTERISTICS

DC CHARACTERISTICS

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
VDD	Supply for digital circuit		1.65		3.3	V
V _{DD2/3}	Supply for bias & pump		2.7		3.3	V
V _{LCD}	Charge pump output	V _{DD2/3} = 2.8V, 25 ^o C		15.2	18	V
VD	LCD data voltage	V _{DD2/3} = 2.8V, 25 ^o C	1.09		1.95	V
VIL	Input logic LOW				$0.2V_{\text{DD}}$	V
VIH	Input logic HIGH		$0.8V_{DD}$			V
Vol	Output logic LOW				$0.2V_{\text{DD}}$	V
Vон	Output logic HIGH		0.8V _{DD}			V
١ _{IL}	Input leakage current				1.5	μΑ
I _{SB}	Standby current	$V_{DD} = V_{DD2/3} = 3.3V$, Temp = 85°C			50	μΑ
CIN	Input capacitance			5	10	PF
COUT	Output capacitance			5	10	PF
Ron(seg)	SEG output impedance	V _{LCD} = 16.5V		850	1100	Ω
Ron(COM)	COM output impedance	V _{LCD} = 16.5V		950	1100	Ω
f _{LINE}	Average line rate	LC[4:3] = 10b, 25 ^o C	-10%	37.0	+10%	Klps

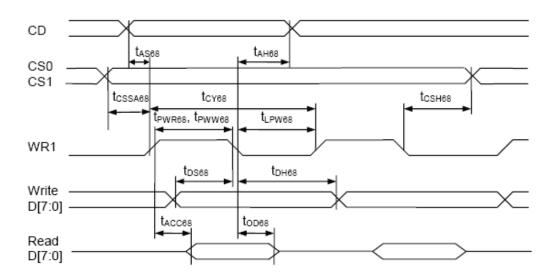
8. TIMING CHARACTERISTICS



Parallel Bus Timing Characteristics (for 8080 MCU)

 $(2.5V \le V_{DD} < 3.3V, Ta = -30 \text{ to } +85^{\circ}C)$

Symbol	Signal	Description	Condition	Min.	Max.	Units
t _{asso} t _{ahso}	CD	Address setup time Address hold time		0 0	-	nS
toyso		System cycle time 16-bit bus (read) (write) 8-bit bus (read) (write)	LC[7:6]=10b LC[7:6]=01b	170 130 100 80 90	-	nS
t _{PWR80}	WR1	Pulse width 16-bit (read) 8-bit		85 50	-	nS
t _{PWW80}	WR0	Pulse width 16-bit (write) 8-bit	LC[7:6]=10b LC[7:6]=01b	65 40 45	-	nS
t _{HPW80}	WR0, WR1	High pulse width 16-bit bus (read) (write) 8-bit bus (read) (write)	LC[7:6]=10b LC[7:6]=01b	85 65 50 40 45	_	nS
t _{DS80} t _{DH80}	D0~D15	Data setup time Data hold time		30 0	-	nS
t _{ACC80} t _{OD80}		Read access time Output disable time	C _L = 100pF	- 15	60 30	nS
T _{CSSA80} t _{CSH80}	CS1/CS0	Chip select setup time		5 5		nS

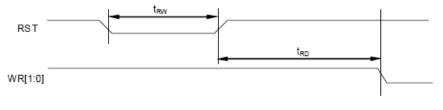


Parallel Bus Timing Characteristics (for 6800 MCU)

(2.5V \leqslant V_{DD} < 3.3V, Ta= –30 to +85 $^{\circ}\mathrm{C})$

Symbol	Signal	Description	Condition	Min.	Max.	Units
t _{ases} t _{ahes}	CD	Address setup time Address hold time		0 0	-	nS
t _{CY88}		System cycle time 16-bit bus (read) (write) 8-bit bus (read) (write)	LC[7:6]=10b LC[7:6]=01b	170 130 100 80 90	_	nS
t _{PWR68}	WR1	Pulse width 16-bit (read) 8-bit		85 50	-	nS
t _{PWW68}		Pulse width 16-bit (write) 8-bit	LC[7:6]=10b LC[7:6]=01b	65 40 45	-	nS
t⊥pw68		Low pulse width 16-bit bus (read) (write) 8-bit bus (read) (write)	LC[7:6]=10b LC[7:6]=01b	85 65 50 40 45	-	nS
t _{DS68} t _{DH68}	D0~D7	Data setup time Data hold time		30 0	-	nS
t _{ACC68} t _{OD68}		Read access time Output disable time	C _L = 100pF	- 15	60 30	nS
t _{CSSA68} t _{CSH68}	CS1/CS0	Chip select setup time		5 5		nS

RESET TIMING





(1.65V ≤ V_{DD} < 3.3V, Ta= -30 to +85°C)

Symbol	Signal	Description	Condition	Min.	Max.	Units
t _{RW}	RST	Reset low pulse width		3	-	μS
t _{RD}	RST, WR	Reset to WR pulse delay		10	-	mS

9. CONTROL AND DISPLAY INSTRUCTION

The following is a list of host commands supported by UC1698u

1: Data 1: Data C/D: 0: Control, W/R: 0: Write Cycle, #: Useful Data bits

1: Read Cycle

$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		#: Useful Data bits	—: Don't Care												
2 Read Data Byte 1 1 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #		Command	C/D	W/R		D6	D5	D4	D3	D2	D1	D0			Default
Bit Constant CE MX MY VA DE WS MD MS Get Status Ver PMO 3 Get Status & PM 0 1 Ver PMO(EG) PMO(Poduc Code, N/A 4 Set Column Address LSB 0 0 0 0 1 0 # # # # Set Cal(Column Address LSB 0 0 0 0 1 0 1 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #	1		1	0			#					#	Write 1 I	oyte	
3 Get Status & PM 0 1 Ver PMO[6:0] PMO[1:0] PMO(1:0]	2	Read Data Byte	1	1			#				#			4	N/A
Image: Column Address LSB 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 0 1 # # Set CA[6:4] 0 5 Set Pore Control 0 0 0 1 0 1 0 0 1 0 0 1 0 0 0 0 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 0 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 0 0 1 <t< td=""><td></td><td></td><td></td><td></td><td></td><td>MX</td><td>MY</td><td></td><td></td><td></td><td>MD</td><td>MS</td><td></td><td></td><td></td></t<>						MX	MY				MD	MS			
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	3	Get Status & PM	0	1											N/A
4 Set Column Address MSB 0 0 0 1 0 # # # Set CA[6:4] 0 5 Set Temp, Compensation 0 0 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 0 0 0 0 1 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0			_	_											
	4		-	-	-	-	-	-							-
6 Set Power Control 0 0 0 1 0 # # Set PC[1:0] 100 7 Set Adv. Program Control 0 0 0 0 1 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	-		-	-	-		-	-	-						-
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			-	-											0
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$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	9		-	-	-			-							-
10 (double-byte command) 0 0 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # <td></td> <td></td> <td>-</td> <td>-</td> <td>_</td> <td></td>			-	-	_										
11 Set Partial Display Control 0 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 0 1 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 0 1 0 0 0 0 1 0 0 0 0 1 0 0 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 1 1 0 1 1 0 1 1 0 1 1 1 1 1 1 1 1 <td< td=""><td>10</td><td>(double-byte command)</td><td></td><td>-</td><td></td><td></td><td></td><td></td><td></td><td>-</td><td>-</td><td></td><td>Set PM</td><td>7:0]</td><td>40H</td></td<>	10	(double-byte command)		-						-	-		Set PM	7:0]	40H
12 Set RAM Address Control 0 0 1 0 0 1 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #<	11		0	0	1	0	0	0	0	1	0	#	Set LC	[8]	0
13 Set Fixed Lines 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 1 0 0 1 0 0 1 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 0 1 0 0 0 0 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1	12		0	0	1	0	0	0	1	#	#		Set AC[2:01	001b
14 Set Line Rate 0 0 1 0 1 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	42		0	0	1	0	0	1	0	0	0				0
15 Set All-Pixel-ON 0 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 1 1 0 1 1 0 0 0 1 1 0 1 1 1 0 1 1 1 0 1 1 1 1 0	13	Set Fixed Lines	0	0	#	#	#	#	#	#	#	#	Set (FLI,	FLB}	U
16 Set Inverse Display 0 0 1 0 1 1 1 # Set DC[0] 0 17 Set Display Enable 0 0 1 0 1 0 1 1 1 # # Set DC[0] 0 18 Set LCD Mapping Control 0 0 1 1 0 0 1 # # # # Set DC[0] 0 19 Set N-Line Inversion 0 0 1 1 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 1 0 0 0 0 0 1 1 1 0 0 0 1 1 1 0 0			0	-	1	-	1	-	0	0	#	#	Set LC[4	4:3]	10b
17 Set Display Enable 0 0 1 0 1 # # # Set DC[4:2] 110b 18 Set LCD Mapping Control 0 0 1 1 0 0 # # # Set LC[2:0] 0 19 Set N-Line Inversion 0 0 1 1 0 0 0 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #			-	-		-	· ·	-	-		-				-
18 Set LCD Mapping Control 0 0 1 1 0 0 0 # # # Set LC[2:0] 0 19 Set N-Line Inversion 0 0 1 1 0 0 1 0 0 0 1 D 0 0 0 0 0 0 1 D 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 <td>16</td> <td>Set Inverse Display</td> <td>~</td> <td>-</td> <td></td> <td>-</td> <td></td> <td>-</td> <td>-</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>-</td>	16	Set Inverse Display	~	-		-		-	-						-
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21 Set Color Mode 0 0 1 1 0 1 # # Set LC[7.6] 10b 22 Set COM Scan Function 0 0 1 1 0 1 # # # Set CSF[2:0] 000b 23 System Reset 0 0 1 1 0 0 1 0 System Reset N/A 24 NOP 0 0 1 1 0 0 1 1 No operation N/A 24 NOP 0 0 1 1 1 0 0 1 1 No operation N/A 25 Set Test Control (double-byte command) 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 1 1 1 1 0 1 1 1 <td>19</td> <td>Set N-Line Inversion</td> <td>0</td> <td>0</td> <td>1</td> <td>1</td> <td>0</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>Set NIV</td> <td>[4:0]</td> <td>1DH</td>	19	Set N-Line Inversion	0	0	1	1	0						Set NIV	[4:0]	1DH
22 Set COM Scan Function 0 0 1 1 1 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #	20		0	0	1	1	0	1	0	0	-	#	Set LC	[5]	0 (BGR)
23 System Reset 0 0 1 1 0 0 1 0 0 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 1 0 0 1 1 1 0 1 1 <th1< th=""> <th1< th=""> <th1< th=""> <th1< td=""><td>21</td><td></td><td>0</td><td>-</td><td>1</td><td>1</td><td>0</td><td>1</td><td>0</td><td></td><td></td><td>#</td><td>Set LC[</td><td>7:6]</td><td>10b</td></th1<></th1<></th1<></th1<>	21		0	-	1	1	0	1	0			#	Set LC[7:6]	10b
24 NOP 0 0 1 1 1 0 0 0 1 1 No operation N/A 25 Set Test Control (double-byte command) 0 0 1 1 1 0 0 1 TT For testing only. Do not use. N/A 26 Set LCD Bias Ratio 0 0 1 1 1 0 0 1 TT For testing only. Do not use. N/A 26 Set LCD Bias Ratio 0 0 1 1 1 0 0 1 Set BR[1:0] 11b: 12 27 Set COM End 0 0 1 1 1 0 0 1 Set			<u> </u>	-	1	1	0	•			#				000b
25 Set Test Control (double-byte command) 0 0 1 1 1 0 0 1 TT For testing only. Do not use. N/A 26 Set LCD Bias Ratio 0 0 1 1 1 0 1 TT For testing only. Do not use. N/A 26 Set LCD Bias Ratio 0 0 1 1 1 0 0 # # # # # # # # # # # # # Do not use. N/A 27 Set COM End 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 1 0 0 1 <															
25 (double-byte command) 0 0 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # <td>24</td> <td></td> <td>,</td> <td>-</td> <td></td> <td></td> <td></td> <td>-</td> <td>-</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>N/A</td>	24		,	-				-	-						N/A
26 Set LCD Bias Ratio 0 0 1 1 1 0 1 0 # # Set BR[1:0] 11b: 12 27 Set COM End 0 0 1 1 1 1 0 0 0 1 1 1 0 0 0 1 159 28 Set COM End 0 0 1 1 1 1 0 0 1 0 0 1 159 28 Set Partial Display Start 0 0 1 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 1 1 1 0 0 0	25		-	-	-			_	-	-		-			N/A
27 Set COM End 0 0 1 1 1 1 1 0 0 0 1 1 1 1 0 0 0 1 1 1 1 0 0 0 1 1 1 1 1 1 0 0 1 1 1 1 1 0 0 1 1 0 0 1 1 0 0 1 0 0 1 1 1 1 0 0 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 0 0 1 1 1 1 1 1 1 <t< td=""><td>20</td><td>· · · · ·</td><td>•</td><td>-</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>441- 40</td></t<>	20	· · · · ·	•	-											441- 40
27 Set COM End 0 0 - # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # <t< td=""><td></td><td>Set LCD Blas Ratio</td><td>-</td><td></td><td>-</td><td></td><td></td><td>-</td><td></td><td></td><td></td><td></td><td>Set BR</td><td>1:0]</td><td>110:12</td></t<>		Set LCD Blas Ratio	-		-			-					Set BR	1:0]	110:12
28 Set Partial Display Start 0 0 - # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #	27	Set COM End	-	0					#	#			Set CEN	[6:0]	159
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 0 1 1 1 0 1 1 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 1 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 <th1< th=""> <th1< th=""> <th1< th=""></th1<></th1<></th1<>	28	Sot Partial Display Start	-	-	1				-	-		-	Set DST	16:01	0
29 Set Partial Display End 0 0 - # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # </td <td>20</td> <td>Set l'artial Display Start</td> <td>-</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>561 051</td> <td>[0.0]</td> <td>Ŭ</td>	20	Set l'artial Display Start	-										561 051	[0.0]	Ŭ
Starting Column Address 0 0 - # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # <td>29</td> <td></td> <td>-</td> <td>-</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>Set DEN</td> <td>[6:0]</td> <td>159</td>	29		-	-									Set DEN	[6:0]	159
31 Set Window Program 0 0 1 1 1 1 0 1 0 1 1 0 1 1 1 0 1 1 1 1 0 1 1 1 1 0 1 1 1 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	30	Set Window Program Starting Column Address	-	-								-			0
Starting Row Address 0 0 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #	21	Set Window Program	0	0	1	1	1	1	0	1	0	1	Sharad	Set	0
32 Set Window Program 0 0 1 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 1 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	51	Starting Row Address	0												U
33 Set Window Program 0 0 1 1 1 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 <th1< th=""> 1</th1<>	32	Set Window Program												Set WPC1	127
Ending Row Address 0 0 # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # # #	22	Set Window Program	0	0	1	1	1	1	0	1	1	1		Set	159
25 Set MTD Operation control 0 0 1 0 1 1 1 1 0 0 0 Set MTD (14-0) 10H													WPP1		
35 Set MTP Operation control 0 0 # # # # # # # Set MTPC[4:0] 10H			-	-					· ·	-	-				
	35	Set MTP Operation control				-	-					#	Set MTP	C[4:0]	10H

	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Action		Default
36	Set MTP Write Mask	0 0 0	0 0 0	1 - -	0 # -	1 # -	1 # -	1 # -	0 # -	0 # #	1 # #	Set MTPN MTPM1[0
37	Set V _{MTP1} Potentiometer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	0 #	0 #		Set MTP1	N/A
38	Set V _{MTP2} Potentiometer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	0 #	1 #	Shared with Window	Set MTP2	N/A
39	Set MTP Write Timer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	0 #	Program commands	Set MTP3	N/A
40	Set MTP Read Timer	0 0	0 0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	1 #		Set MTP4	N/A

NOTE:

- · All other bit patterns other than commands listed above may result in undefined behavior.
- The interpretation of commands (36)~(40) depends on the setting of register MTPC[3].
 - Commands (37)~(40) are shared with commands (30)~(33). These two sets of commands share exactly the same code and control registers. When MTPC[3]=0, they are interpreted as Window Program commands and registers. When MTPC[3]=1, they function as MTP Control commands and registers.
- After MTP ERASE or PROGRAM operation, before resuming normal operation, please always

 a) Remove TST4 power source,
 - b) Do a full V_{DD} ON-OFF-ON cycle.
- Under 16-bit bus mode and CD=0, D[15:8] is ignored and only D[7:0] is used. As a result, the bus cycles
 for commands under 16-bit bus and 8-bit bus are the same, and double-byte commands still need two
 bus cycles under 16-bit bus mode.

Example:

8-bit bus mode:

Set PL[1:0] = 2'b11 :	D[7:0] = 0010 1011
Set PM[7:0] = 8'h8b :	1 st D[7:0] = 1000 0001
	2 nd D[7:0] = 1000 1011

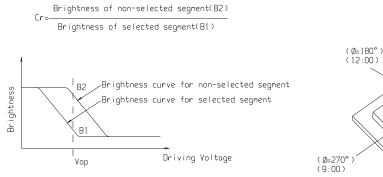
16-bit bus mode:

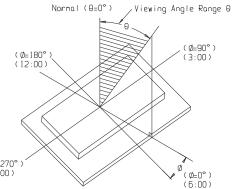
Set PL[1:0] = 2'b11:	D[15:0] =	0000 0000	0010 1011
Set PM[7:0] = 8'h8b: 1 st	D[15:0] =	0000 0000	1000 0001
2 nd	D[15:0] =	0000 0000	1000 1011

$\frac{10. \ ELECTRO-OPTICAL \ CHARACTERISTICS}{(V_{DD} = 3.3V, \ Ta = 25^{\circ}C)}$

Item	Symbol	Condition	Min	Тур	Max	Unit
Operating Voltage for LCD		Ta =-20°C	16.2	16.5	16.8	
	Vop	$Ta = 25^{\circ}C$	15.7	16.0	16.3	V
		$Ta = 70^{\circ}C$	15.2	15.5	15.8	
Demanating	Tr	Ta = 25°C		250	500	ms
Response time	Tf			300	600	ms
Contrast	Cr	$Ta = 25^{\circ}C$	2	4		
Viewing angle range	θ	Cr≥2	-35		+35	deg
	Φ	01≥2	-35		+40	deg

The following charts is for your reference of the data in the above form.





11. BACK LIGHT CHARACTERISTICS

LCD Module with edge LED Backlight. Electrical ratings. $Ta = 25^{\circ}C$

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Current	IF	VF=3.5V		105	140	mA
Reverse Current	IR	VR=5.0V			70	uA
Luminous Intensity (Without LCD)	Lv	VF=3.5V	250	300		cd/m ²
Color coordinate(without LCD)	λρ	VF=3.5V	X=0.26 Y=0.26		X=0.30 Y=0.30	
Color			white			

Note:

During high temperature operation, please refer to the LED spec(current vs temperature) to decide the current of single LED.

12. PRECAUTION FOR USING LCD/LCM

After reliability test, recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours

(average) under ordinary operating and storage conditions room temperature $(20\pm8^{\circ}C)$, normal humidity (below 65% RH), and in the area not exposed to direct sun light. Using LCM beyond these conditions will shorten the life time.

Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting Orient Display.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or

twisting. Elastomer contacts are very delicate and missing pixels could result from slight

dislocation of any of the elements.

- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.

- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: $350^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

Orient Display LCDs and modules are not consumer products, but maybe incorporated by Orient Display's customers into consumer products or components thereof, Orient Display does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of Orient Display is limited to repair or replacement on the terms set forth below. Orient Display will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Orient Display and the customer, Orient Display will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Orient Display general LCD inspection standard . (Copies avail able on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.

13. LCM test criteria

1. Objective

The criteria is applied for consolidating the LCM quality standard between Orient Display and customer in finished products acceptance inspection and shipment, to guarantee the products quality to meet with customer's demand.

2. Scope

2.1 This criteria is applicable to all the LCM products produced by Orient Display.

3. Inspection equipment

Function Tester, Vernier Calipers, Microscope, Magnifier, ESD Wrist Strap, Finger Cover

、Labels、 High-Low Temperature Oven、 Refrigerator、 Constant Voltage Power Supply (

DC), Desk Lamp, etc.

4. Sampling Plan and Reference Standard

4.1.1 According to GB/T 2828.1---2003/ISO2859-1:1999, single sampling under normal

inspection, general inspection level II.

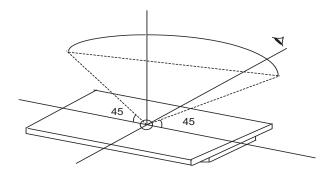
Item of Inspection	Times of Sampling	AQL Judgment
Cosmetic	II Single Sampling	MA=0.4 MI=1.5
Mechanical	N=3	C=0
Functional	II Single Sampling	MA=0.4 MI=1.5

- 4.1.2 GB/T 2828.1---2003/ISO2859-1:1999 Counting and sampling procedures and sampling table for Batch-to-Batch Inspection.
- 4.1.3 GB/T 1619.96 Test method for TN LCD.
- 4.1.4 GB/T 12848.91 General Specification for STN LCD.
- 4.1.5 GB2421-89 Basic Environmental Test Procedures for Electrical and Electronic Products
- 4.1.6 IPC-A-610C Acceptance Condition for Electrical Assemblies.

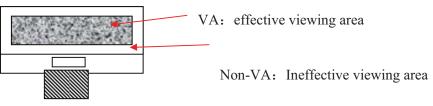
5. Inspection Condition and Inspection Reference

- 5.1 The ambient temperature and humidity are 25 ± 5 °C and $45\pm20\%$ RH respectively, and the ambient luminance should be more than 300 cd/cm². The distance between inspector's eyes and the LCD panel should be 30cm away. Normally we inspect products with reflected light, when we inspect the LCD produces with backlight turned on, the ambient luminance should be less than 100 cd/cm².
- 5.2 The LCD should be test with 45° both left and right side, 0-45° both upside

and downside (if for STN product, $-20-55^{\circ}$ is needed).



5.3 Definition of VA



- 5.4 Inspection with viewed eyes (not including defect size measure by magnifiers).
- 5.5 Electrical property

Inspect with the test jig to meet with the requirement indicated in the approved documents, including the pattern design and the display performance.

- 5.5.1 Testing voltage (V)
 - 5.5.1.1 According to the inspection of test jig and production specification the test voltage setting is Vop ± 0.3 V when the Vop is under 9.0V, and Vop $\pm 3\%$ Vop when the Vop is above 9.0V.
 - 5.5.1.2 As per the product with the fixed voltage the test voltage setting is same as Vop and keeps the constant voltage through the internal circuit. And the limited sample on the voltage range is needed if necessary.
- 5.5.2 Current Consumption (I) : refer to product document and approval drawing to confirm it.

6. Inspection Item and Acceptance Standard

- 6.1 Outer dimension: For the outer dimension and the sizes which could influence the assembly at the customer's side, it should be in accordance to the approval drawing, and it belongs to the major defect.
- 6.2 Functional Test:

No.	Item	Description	MAJ	MIN	Accept standard
-----	------	-------------	-----	-----	--------------------

6.2.12	Pattern distortion	Width of pattern displayed is wider , narrower or deformed from the specifications caused by wrong alignment, i.e. extra heave or missing: Ia-Ib ≤		~	Acceptable Ia-Ib >1/4W, rejected
6.2.11	pinhole/white spot	The phenomena of missing patterns when turned on caused by missing of ITO fragment. d = (X+Y)/2		~	refer to spot/line standard
6.2.10	PI black/white spot	Partial black and white spot are visible while changing display content due to the PI layer defective		~	refer to the spot/line criteria for the visible spots when display image stopped, others O
6.2.9	Dim segment	Under the normal voltage, the contrast of segment are uneven		~	Reject or refer to samples
6.2.8	Extra segment	Display of wiring, or extra pattern, caused by wrong alignment or insufficient corrosion		~	refer to spot/line standard
6.2.7	Slow response	Response of some segments is different with others when turned on or off the LCD	~		Rejected
6.2.6	Display dim/dark	The contrast of LCD is too dark or too dim under normal operation	~		Beyond the voltage tolerance, Rejected
6.2.5	Viewing angle wrong	The direction with the best display of patterns should be as customer required (or refer to the approval samples)	~		Rejected
6.2.4	Display error/abnormal	The display pattern and display order is not as required under the normal scanning procedure.	~		Rejected
6.2.3	No display/no action	No segment is displayed when the product is connected correctly.	~		Rejected
6.2.1	Missing Segment	Any missing segment caused by an open circuit; Any missing COM, pattern, dot or segment caused by an open circuit or poor crossover contact	4		Rejected

		1/4W(W is the normal width)		
6.2.13	High current	the current is bigger than regulated value.	\checkmark	Rejected

6.3 LCD Visual Defect

6.3.1 Dot defect(defined within VA, out of VA spots not accounted)

Defect item	Average diameter (d)	Accept numbers	MAJ	MIN
Spot defect	d≤0.2	3		
(black spot, foreign	0.2 <d≤0.25< td=""><td>2</td><td></td><td>~</td></d≤0.25<>	2		~
material, nick, scratches, LC defect)	0.25 <d≤0.30< td=""><td>1</td><td></td><td></td></d≤0.30<>	1		

6.3.2 Line defect(defined within VA, out of VA spots not accounted)

Defective item	length(L)	width(W)	Accept numbers	MAJ	MIN		
line defect (scratch, liner	≤5.0	≤0.02	3				
foreign material)	≤3.0	≤0.03	3		,		
	≤3.0	≤0.05	1		~		
note: 1. If the width is bigger than 0.1mm, it can be treated as spot defect.							

6.3.3 Polarizer Air Bubble (defined within VA, out of VA spots not accounted)

Defective item	Average diameter (d)	Accept numbers	MAJ	MIN
polarizer Air Bubble, Concave-Convex Dot	d≤0.3	3		
	0.3 <d≤0.5< td=""><td>2</td><td></td><td>~</td></d≤0.5<>	2		~
$ \begin{array}{c} & \downarrow & W \\ \hline & \downarrow & d = (w+1)/2 \end{array} $	0.5 <d≤0.8< td=""><td>1</td><td></td><td></td></d≤0.8<>	1		

6.3.4 Damaged(For the products with LCD edge expose to outside without mental frame, including products in COG, with H/S or assembled with backlight)

No.	Item	Acceptance Standard		MAJ	MIN
6.3.4.1	Chin on load		(mm)		\checkmark
	Chip on lead	Х	≤1/8L		
		Y	≤1/3W		

		Z	≤1/2t			
		Accept number	2			
		When $Y \le 0.2$ side without $Y \le 1/2W$ ma	2mm, neglect the lead, and not perfo ax, accept.	ength of X, ch rated, when X	ip on the $\leq 1/10L$,	
	chip on corner(ITO lead)		(mm)	MAJ	MIN	
		Х	Not enter into			
6.3.4.2		Y	frame epoxy and touch the lead			
	z z z z z z z z z z z z z z z z z z z	Z	≤t		\checkmark	
		Accept numbers	2			
		Chips on corner refer to 6.3.4.3 and must be out of the frame epoxy. If chips on lead, refer to 6.3.4.1				
	Chip on sealed area (outer chip)		(mm)	MAJ	MIN	
		Х	≪1/8 L			
		Y	≤1/2H		,	
6.3.4.3		Z	$\leq 1/2t$		\checkmark	
0.511.6		Accept numbers	2			
	z #	standard for o lead, the valu without lead.		e opposite side	e of ITO on the side	
note: t frame ep	-glass thickness, Llength, HThe boxy. W—The width of ITO lead	e distance betw	veen the LCD edge	to the inner o	fLCD	

6.3.5 Others

No.	Item	Description	MAJ	MIN	Accept standard
6.3.5.1	Newton/ B/G color uniformity not good	There exists more than one color on one product or same batch.		\checkmark	Reject or refer to limited sample
6.3.5.2	Leakage(LC)	/	\checkmark		Rejected
6.3.5.3	No protective film	/		\checkmark	Rejected

6.4 Backlight components

No.	Item	Description	MAJ	MIN	Accept standard
6.4.1	Backlight not work, wrong color	/	\checkmark		Rejected
6.4.2	Color deviation	Turn backlight, the color differ from the sample, do not match the drawing after testing		\checkmark	Refer to sample and drawing
6.4.3	Brightness deviation	Turn on backlight, the brightness is differ from the sample, or do not match the drawing after testing, or over $\pm 30\%$ compare with sample if drawing not specified.		~	Refer to sample and drawing
6.4.4	Uneven brightness	Turn on the backlight, the brightness is uneven on the same LED and beyond the specification of drawing.		\checkmark	Refer to sample and drawing
6.4.5	Spot/line scratch	There is stain, scratches on backlight when turn on.		\checkmark	Refer to 6.3.1/6.3.2

6.5 Mental frame

No.	Item	Description	MAJ	MIN	Accept standard
6.5.1	material/surface	Mental frame/surface approach inconsistent with specification.	\checkmark		Rejected
6.5.2	Twist not qualified/without twisting	Twist method/direction wrong, not twist as required	\checkmark		Rejected
6.5.3	Oxidized steak, paint stripped, color changed, dented mark, scratches	1.Oxidized steak on the surface of the metal frame;2. front surface paint scratch to substrate, the stripped spot ≤0.8mm and exceed 3 areas;3.line defect in length≤5.0mm and width ≤0.05mm exceed 2 areas, front dent, bubble and side surface have paint stripping to substrate≤1.0mm exceed 3 areas, line defect in width ≤0.05mm exceed 3 areas.		\checkmark	Rejected
6.5.4	Burred	Burr is too long, enter into viewing area		\checkmark	Rejected

6.6 PCB/COB

No.	Item	Description	MAJ	MIN	Accept standard
6.6.1	Epoxy Cover Improper	 The Pad within the round white mark is exposed to outside. The height of epoxy covers beyond 		\checkmark	Rejected

		-				1
			document /drawing specification.			
		3.	······································			
			white round mark and the maximum			
			overage is 2mm more than the radius of			
			white mark.			
		4.	Clear liner mark on COB surface or			
			pinhole that it is possible to penetrate			
			through the epoxy to chip.			
		5.	The pinhole diameter over 0.25mm or			
			other material on COB surface.			
		1.	PCB pad surface can not be oxidized or			
			contaminated.			
		2.	PCB can not appear bubbles after			
			through the reflow oven.			
	PCB	3.	Copper lead due to the PCB green oil			
6.6.2	cosmetic		drop or scratches.		1	Rejected
	defect		If repaired by adding the green oil,			5
			circuit diameter Φ can not over 1.3mm,			
			other diameter Φ can not over 2.6mm,			
			total less than 10 areas. Otherwise			
			reject.			
		1	PCB components inconsistent with			
		1.	drawing. Wrong components, more or			
			less pa, polar reverse (The bias circuit			
			of LCD voltage or BL limit current			
			value adjustment is not controlled if not			
			c c			
	Components	2	special specified.)			
6.6.3	error	2.	The JUMP short of PCB should be	√		Rejected
	CIIOI	2	consistent of the mechanical drawing.			
		3.	The components is specially required by			
			the customers and specified in			
			mechanical drawing / technical			
			documents, the components			
			specification should be conformed to			
			technique demand. Otherwise rejected			

6.7 SMT part (Refer to IPC-A-610C if not specified)

No.	Item	Description	MAJ	MIN	Accept standard
6.7.1	Soldering defect	Cold soldering, false solder, missing solder, tin crack, tin un-dissolved happened with soldering.		\checkmark	Rejected
6.7.2	Solder ball/splash	Solder ball/tin dross drop lead to solder short.		\checkmark	Rejected
6.7.3	DIP parts	DIP parts, keypad, connection appear floating and tilted.		\checkmark	Rejected

6.7.4	Spot weld shape	The spot weld should be inner dent, can not form to cover solder or less solder or icicle, otherwise reject	\checkmark	Rejected
6.7.5	Component foot exposed	For the DIP type components, after soldered, 0.5~2mm component foot must be remained, and should not damage the solder surface nor fully covered the component foot. Otherwise rejected.	\checkmark	Rejected
6.7.6	Appearance poor	After soldering, the solder residues appear brown or black. PCB solder spot remained white mist residues after clean.	\checkmark	Rejected

6.8 Heating pressure part (including H/S, FPC, etc.)

No.	Item	Description	MAJ	MIN	Accept standard
6.8.1	Out of specif ication		\checkmark		Rejected
6.8.2	Size/position	The size of heating material should be within the specification of the drawing, the contact area of conducted material should be attached more than 1/2 of the body (ITO, PDA, etc)		\checkmark	Acceptable
6.8.3	Heat pressure dirty	The obstacle existed in non-conductive heating area and not lead to short, or existed in conductive area but the obstacle is less than 50% of pressure area, it is acceptable.		\checkmark	Acceptable
6.8.4	Folding defect			\checkmark	Refer to limited sample

6.9 Connector and other parts

No.	Item	Description	MAJ	MIN	Accept standard
6.9.1	Specification improper	The specification of connector and other components do not conform to the drawing as required.	\checkmark		Rejected
6.9.2	Position and order	Solder position and Pin 1 should be consistent with the drawing.		\checkmark	Rejected

6.9.3	Cosmetic	 The body of outer component and the PIN has flux. The deformation bigger of PIN connector is bigger than 1/2 of PIN width. 	~	Rejected
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6.10 General cosmetic

No.	Item	Description	MAJ	MIN	Accept standard
6.10.1	Connection material	Copper lead on FPC pad or the pin terminal of H/S, FFC and damaged. FPC,FFC, COF,H/S connected material curved (except for original). FPC、PCB pad is bigger than 1PIN width. FPC/FFC material segment, crease exceed the specification.		\checkmark	Rejected
6.10.2	Stiffing type defect	Stiffening tape is not covered or fully covered the product's circuit needs to be protected. (Like H/S, FFC, FPC) or cover to the output pin.		\checkmark	Rejected
6.10.3	Visual dirty	Dirty on surface of finished products, residual glue, solder spatter or solder ball remain on non-soldered area of PCB/COB. The defective mark or label on product does not remove.		\checkmark	Rejected
6.10.4	Assembly black spot	The spot or black dots found after assembly the products with backlight or diffuser.		\checkmark	Refer to 6.3.1
6.10.5	Product mark	Part number and batch mark is not conformed with the technical requirement and position, not clear or without mark.		\checkmark	Rejected
6.10.6	Inner packing	Packing is inconsistent with requirement, short or over load, Packing is inconsistent with shipment mark/ order demand.		\checkmark	Rejected

7. Reality test

Test item	Condition	Time(hrs)	Accept standard
High Temp Storage	80°C	120	No abnormalities in functions and appearance
High Temp Operating	70°C	120	
Low Temp Storage	-30°C	120	
Low Temp Operating	-20°C	120	
Temp& Humidity Test	40°C/90%RH	120	
Temp Shock	$-20^{\circ}C \leftarrow 25^{\circ}C \rightarrow +70^{\circ}C$	10 cycles	
	$(30 \min \leftarrow 5 \min \rightarrow 30 \min)$		

Note: ①The customer should inform the special requirements on the reliability test to Orient Display when

starting the project.

②For high/low temperature test under both storage and operating condition, the temperature is referrer to the product specification.

③For temperature test ± 5 °C deviation could be accepted.

8. Packing

- 8.1 Product packing must meet the requirement of packing design. The label should be qualified by QA department and it includes the Item No., specification sheet, quantity and production date. Incomplete or mistake is regarded as not qualified.
- 8.2 When the safety of the packing exist the problems, including shock resistance, moisture resistance, anti-ESD and press resistance, it is regarded as not qualified.
- 8.3 When customer has special requirement on packing, which is confirmed and accepted by Orient Display, inspect and release the products as customer required.
- 8.4 For RoHS or non-RoHS products it should be distinguished with obvious label. Currently we adopt the "RoHS" label for all the products meet the RoHS compliance, or using the labels / marks as the customer required.

9. Others

9.1 For unregulated and compromised items, reference shall be taken to mutual agreements and limit samples.